

Final Product/Process Change Notification

Document #:FPCN23751ZE Issue Date: 04 May 2022

Title of Change:	Fabrication Site Transfer from Oudenaarde (Belgium 6") to onsemi Pocatello, Id (USA 8") [Batch 2].
Proposed Changed Material First Ship Date:	11 Nov 2022 or earlier if approved by customer
Current Material Last Order Date:	01 Sep 2021. This date was carried forward from IPCN23751Z Orders received after the Current Material Last Order Date expiration are to be considered as orders for new changed material as described in this PCN. Orders for current (unchanged) material after this date will be per mutual agreement and current material inventory availability.
Current Material Last Delivery Date:	10 Nov 2022 The Current Material Last Delivery Date may be subject to change based on build and depletion of the current (unchanged) material inventory
Product Category:	Active components – Discrete components
Contact information:	Contact your local onsemi Sales Office or NoorArdila.Shaharuddin@onsemi.com
PCN Samples Contact:	Contact your local onsemi Sales Office to place sample order. Sample requests are to be submitted no later than 45 days after publication of this change notification. Samples delivery timing will be subject to request date, sample quantity and special customer packing/label requirements.
Sample Availability Date:	24 May 2022
PPAP Availability Date:	31 May 2022
Additional Reliability Data:	Contact your local onsemi Sales Office or Nicky.Siu@onsemi.com
Type of Notification:	This is a Final Product/Process Change Notification (FPCN) sent to customers. The change will be implemented at 'Proposed Change Material First Ship Date' in compliance to J-STD-46 or ZVEI, or earlier upon customer approval, or per our signed agreements. onsemi will consider this proposed change and it's conditions acceptable, unless an inquiry is made in writing within 45 days of delivery of this notice. To do so, contact PCN.Support@onsemi.com .
Change Category	
Category	Type of Change
Process - Wafer Production	Move of all or part of wafer fab to a different location/site/subcontractor, New wafer diameter
Equipment	Production from a new equipment/tool which uses the same basic technology (replacement equipment or extension of existing equipment pool) without change of process.

Description and Purpose:

This is the final notification of the wafer fabrication site transfer from Oudenaarde (Belgium 6") to onsemi Pocatello (USA 8").

The details of the changes are outlined in the tables below.

The transfer is due to the sale of the Oudenaarde facility.

Datasheet specifications and product electrical performance remain unchanged.

	From	То	
Fab Site	Wafer manufacturing in Oudenaarde, Belgium	Wafer manufacturing in onsemi Pocatello, USA	
Wafer size	Wafer diameter 6"	Wafer diameter 8"	

Affected parts with this change will be identified by date code.

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Reason / Motivation for Change:	Acquisition		
Anticipated impact on fit, form, function, reliability, product safety or manufacturability:	The device has been qualified and validated based on the same Product Specification. The device has successfully passed the qualification tests. Potential impacts can be identified, but due to testing performed by onsemi in relation to the PCN, associated risks are verified and excluded. No anticipated impacts.		
Sites Affected:			
onsemi Sites		External Foundry/Subcon Sites	
onsemi Pocatello Idaho, United States		None	
Marking of Parts/ Traceability of Change:	Affected parts with this change will be identified by the date code		

Reliability Data Summary:

QV DEVICE NAME: SZMG2040MUTAG

RMS : \$77111

PACKAGE: 5.5x1.5 UDFN-18

Test	Specification	Condition	Interval	Results
HTRB	JESD22-A108	Ta = 150°C, 100% max rated V	2016 hrs	0/231
HTSL	JESD22-A103	Ta = 150°C	1008 hrs	0/231
TC	JESD22-A104	Ta = -65°C to +150°C	1000 cyc	0/231
HAST	JESD22-A110	130°C, 85% RH, 18.8psig, bias	96 hrs	0/231
uHAST	JESD22-A118	130°C, 85% RH, 18.8psig, unbiased	96 hrs	0/231
PC	J-STD-020, JESD22-A113	MSL 1 @ 260°C	-	-
RSH	JESD22-B106	Ta = 265°C, 10 sec	•	0/30

QV DEVICE NAME: ESDR0502NMUTAG

RMS : \$76742

PACKAGE: UDFN-6, 1.2x1.0mm

Test	Specification	Condition	Interval	Results
HTRB	JESD22-A108	Ta = 150°C, 100% max rated V	2016 hrs	0/231
HTSL	JESD22-A103	Ta = 150°C	1008 hrs	0/231
TC	JESD22-A104	Ta = -65°C to +150°C	1000 cyc	0/231
HAST	JESD22-A110	130°C, 85% RH, 18.8psig, bias	96 hrs	0/231
uHAST	JESD22-A118	130°C, 85% RH, 18.8psig, unbiased	96 hrs	0/231
PC	J-STD-020, JESD22-A113	MSL 1 @ 260°C	-	-
RSH	JESD22-B106	Ta = 265°C, 10 sec	-	0/30

NOTE: AEC-1pager is attached.

To view attachments:

- 1. Download pdf copy of the PCN to your computer
- ${\it 2. Open the downloaded pdf copy of the PCN}\\$
- 3. Click on the paper clip icon available on the menu provided in the left/bottom portion of the screen to reveal the Attachment field

4. Then click on the attached file.

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Electrical characteristics are not impacted.

List of Affected Parts:

Note: Only the standard (off the shelf) part numbers are listed in the parts list. Any custom parts affected by this PCN are shown in the customer specific PCN addendum in the PCN email notification, or on the **PCN Customized Portal**.

Current Part Number	New Part Number	Qualification Vehicle
SZMG2040MUTAG	NA	SZMG2040MUTAG
SZESD7104MUTAG	NA	SZMG2040MUTAG, ESDR0502NMUTAG
SZESD7016MUTAG	NA	SZMG2040MUTAG
SZESD7004MUTAG	NA	SZMG2040MUTAG

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Appendix A: Changed Products

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Product	Customer Part Number	Qualification Vehicle	New Part Number	Replacement Supplier
SZMG2040MUTAG		SZMG2040MUTAG	NA	
SZESD7016MUTAG		SZMG2040MUTAG	NA	
SZESD7104MUTAG		SZMG2040MUTAG, ESDR0502NMUTAG	NA	